

IN THE UNITED STATES DISTRICT COURT
FOR THE NORTHERN DISTRICT OF CALIFORNIA

HYNIX SEMICONDUCTOR, INC.,

Plaintiff,

-v-

RAMBUS, INC.,

Defendant.

RAMBUS, INC.,

Plaintiff,

-v-

HYNIX SEMICONDUCTOR, INC., et al.,

Defendant.

RAMBUS, INC.,

Plaintiff,

-v-

SAMSUNG ELECTRONICS CO., et al.,

Defendant.

RAMBUS, INC.,

Plaintiff,

-v-

MICRON TECHNOLOGY, et al.,

Defendant.

E-FILED - 11/16/07

CASE NO.: C-00-20905-RMW

SEALING ORDER

CASE NO.: C-05-00334-RMW


CASE NO.: C-05-02298-RMW

CASE NO.: C-06-00244-RMW

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3 IT IS HEREBY ORDERED that Rambus Inc.'s Reply in Support of ITS Motion for
4 Summary Judgment No.2 re: Disclosure Duty and Breach of Contract lodged with the court on
5 November 8, 2007 shall be filed under seal.

6 IT IS SO ORDERED.

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8 DATED: November 16, 2007

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12 RONALD M. WHYTE
13 United States District Judge
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2 Copy of Order E-Filed to Counsel of Record:

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